Messrs. Digi-Key

| Issue No.      | : PC-02-064             |
|----------------|-------------------------|
| Date of issue  | : November 15, 2002     |
| Classification | · ■ New□Change□ Renewal |

## **Delivery Specification**

| Product Description                    | : Balun   |
|--|---|
| Product Part Number                    | : EHF2BE0920  |
| Classification of Spec                 | : Individual Product Specification  |
| Applications                           | : Cellular phone  |
|  | For other applications, contact the undersigned in advance.   |
| Term of Validity                       | : November 14, 2007 from the date of issue.   |
| Classification of Spec<br>Applications | : Individual Product Specification : Cellular phone For other applications, contact the undersigned in advance. |

| CUSTOMER USE ONLY   | Receipt Record#: |
|---|------------------|
| This was certainly received by us.  1(one) copy is being returned to you. | Date of receipt: |
| r(one) copy to being retarried to you.                                    | Received by:     |
|   | Title: Dept.:    |

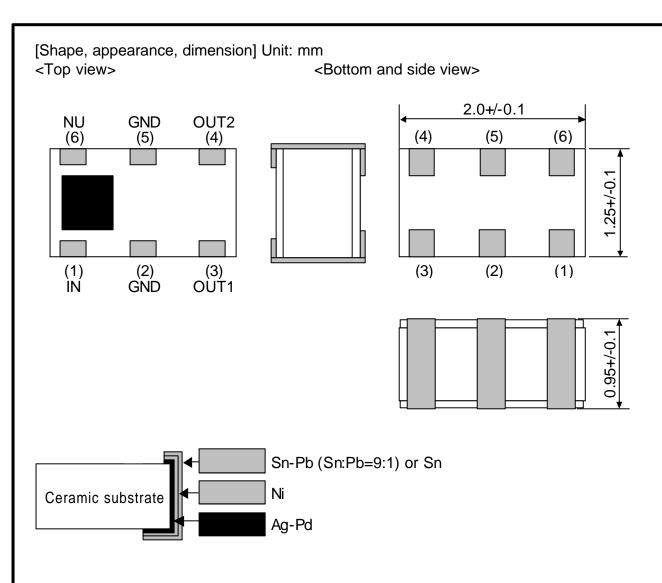
Matsushita Electronic Components Co., Ltd. Network Device Company Module Strategic Business Unit Engineering Group HFD Team

992-1 Aiba Ohno-cho Ibi-gun Gifu 501-0598 JAPAN

Tel: +81-0585-36-2322 Fax: +81-0585-36-2344 Prepared by : H. Ito Checked by : M. Mizuno

Authorized by : M. Mizuno

Title : Manager of Engineering



Note 1) "typ" is used where no dimensional tolerance applies.

| Item                        | Description  |
|-----------------------------|--|
| Appearance/<br>construction | Product surface shall be covered with a protective film, which does not easily separate nor present noticeable unevenness, scratches, pinholes, color changes etc. |
|                             | Terminals shall ensure practically acceptable quality.   |
|                             | Substrate shall be as shown in the drawing with no excessive chippings, scratches, burrs, or cracks.   |
| Marking                     | Shall be legible in black (with printing paste).   |
| Remarks                     | marked side for pin 1.   |

| Balun                         |       | Delive    | ry Specif | ication | EHF2BE0920                         |
|-------------------------------|-------|-----------|-----------|---------|------------------------------------|
| Enact. Date November 15, 2002 | P.S.M | Approval  | Check     | Plan    | Appearance                         |
| Enfo. Date November 15, 2002  |       | M. Mizuno | M. Mizuno | H. Ito  | Drawing No.<br>151-EHF-2BE0920 9-1 |

## [Absolute maximum ratings]

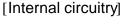
| No. | Item                  | Symbol | Rating | Unit | Remarks           |
|-----|-----------------------|--------|--------|------|-------------------|
| 1   | Maximum input power   | Pmax   | 100    | mW   | DC voltage is 0V. |
| 2   | Operating temperature | Topr   | -30+85 | degC |                   |
| 3   | Storage temperature   | Tstg   | -40+85 | degC |                   |

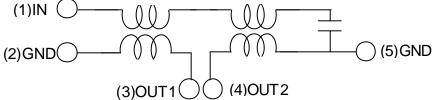
Note: This component cannot apply a DC Bias.

[Electrical characteristics]

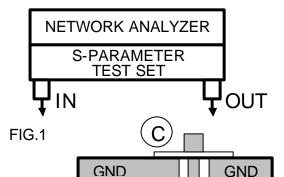
T=-30...+85degC

| No. | Item                          | Test    |      | Unit |      |     |
|-----|-------------------------------|---------|------|------|------|-----|
|     |                               | Circuit | Min. | Тур. | Max. |     |
| 1   | Frequency                     | ı       | 880  | -    | 960  | MHz |
| 2   | Insertion loss (Back to back) | Fig-2   | -    | -    | 1.0  | dB  |
| 3   | Unbalance impedance           | -       | -    | 50   | -    | ohm |
| 4   | Balance impedance             | ı       | -    | 100  | ı    | ohm |
| 5   | Unbalance port VSWR           | Fig-1   | -    | -    | 2.0  | -   |
| 6   | Amplitude balance             | Fig-1   | -1.5 | _    | 1.5  | dB  |
| 7   | Phase balance                 | Fig-1   | 165  | 180  | 195  | deg |





[Measuring circuit]



**GND** 

- < Phase balance measurement >
- •Phase1

A=IN, B=OUT, C=Terminal resistor (50 ohm)

•Phase2

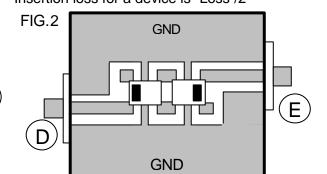
A=IN, C=OUT, B=Terminal resistor (50 ohm)

Phase balance

Phase balance=Phase1-Phase2

< Insertion loss measurement >

Assuming the loss as "Loss" when D=IN, E=OUT Insertion loss for a device is "Loss"/2

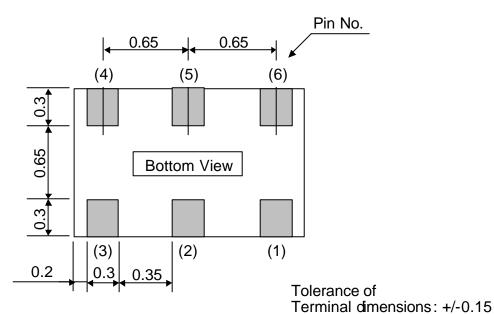


| Balun                         |       | Delive    | y Specif  | ication | EHF2BE0920                         |  |  |
|-------------------------------|-------|-----------|-----------|---------|------------------------------------|--|--|
| Enact. Date November 15, 2002 | P.S.M | Approval  | Check     | Plan    | Specification and measurement      |  |  |
| Enfo. Date November 15, 2002  |       | M. Mizuno | M. Mizuno | H. Ito  | Drawing No.<br>151-EHF-2BE0920 9-2 |  |  |

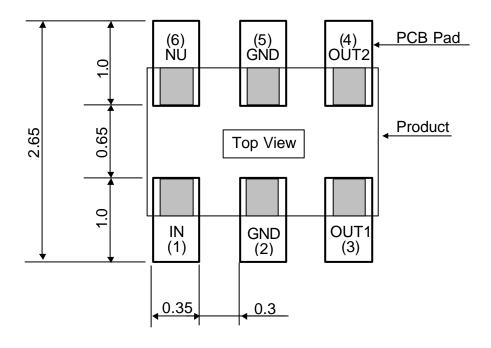
В

## [Terminal dimensions] Unit: mm

## <Bottom>



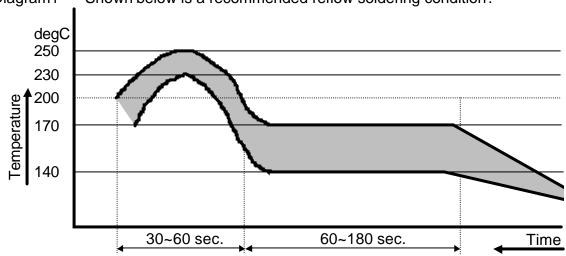
[Recommended PCB pad dimensions] Unit: mm



| Balun                         |       | Deliver   | y Specifi | cation | EHF2BE0920                         |  |  |
|-------------------------------|-------|-----------|-----------|--------|------------------------------------|--|--|
| Enact. Date November 15, 2002 | P.S.M | Approval  | Check     | Plan   | Terminals/Recommended lands        |  |  |
| Enfo. Date November 15, 2002  |       | M. Mizuno | M. Mizuno | H. Ito | Drawing No.<br>151-EHF-2BE0920 9-3 |  |  |

| [Quality characteristic                | s]   |   |  |  |  |  |  |
|--|--|---|--|--|--|--|--|
| Test item                              | Test condition   | Judgment criteria   |  |  |  |  |  |
| High temperature                       | +85degC, 1000h   | No abnormality shall be observed in   |  |  |  |  |  |
| Low temperature                        | -40degC, 1000 h  | appearance or   |  |  |  |  |  |
| High-temperature high-humidity storage | +60degC, 90%RH, 1000h  | electrical<br>characteristics.  |  |  |  |  |  |
| Pressure Pot                           | +121degC, 99%RH, 2.026x10 <sup>5</sup> Pa, 100h  | Characteristics.  |  |  |  |  |  |
| Temperature cycling                    | -40+85degC, Each 30 min., 200cy  |   |  |  |  |  |  |
| Vibration                              | 10500Hz, 10G, in each direction of XYZ, 2h30min.   |   |  |  |  |  |  |
| Impact                                 | 100G, 6mS, Half sinusoidal wave, in each direction of XYZ, 3 times   |   |  |  |  |  |  |
| Shock (Drop)                           | 1.8m, 6 facesx6cy(36 times with 100g Dummy Load)   |   |  |  |  |  |  |
| Electro static discharge               | 200pF, 0 ohm, +/-200V, Each 5 times  |   |  |  |  |  |  |
| Soldering heat resistance              | Manual hot gas: 260+/-10degC, 30 sec., 2 times   | Over 90% of the terminal surface shall be covered   |  |  |  |  |  |
|  | Soldering iron: 260+/-10degC, 3 sec., 2 times  |   |  |  |  |  |  |
|  | Reflow: 260degC peak, 2 times  |   |  |  |  |  |  |
| Solder ability                         | Solder bath: 235+/-5degC, 2 sec.   | Over 95% of the terminal surface shall be covered   |  |  |  |  |  |
|  | Reflow: 230degC  | with solder.  |  |  |  |  |  |
| Board warping                          | Assemble this component on a PC board with 0.8mm thickness using the recommended soldering condition shown below, and apply a bending force of 3mm warping at a rate of 1mm/sec. 5 seconds and 5 times.  45mm 45mm 45mm 45mm | There should not be any cracks in the component or solder joints, no abnormality in electrical characteristics. |  |  |  |  |  |
| Terminal removal                       | minal removal  Solder a component on a PC board using the recommended condition shown below and then press the component sideways at 1mm/sec. Destruction limit 9.8N or greater.   |   |  |  |  |  |  |
| Seating plane co-planarity             | Within 0.1mm   |   |  |  |  |  |  |





| Balun                         | Delivery Specification |           |           |        |  | EHF2BE0920                         |  |  |
|-------------------------------|------------------------|-----------|-----------|--------|--|------------------------------------|--|--|
| Enact. Date November 15, 2002 | P.S.M                  | Approval  | Check     | Plan   |  | Quality Characteristics            |  |  |
| Enfo. Date November 15, 2002  |                        | M. Mizuno | M. Mizuno | H. Ito |  | Drawing No.<br>151-EHF-2BE0920 9-4 |  |  |

### [Cautions for use]

- (1) Operating a product over the maximum rating for even a moment may result in a product failure or breakage. Never use a product in such a condition that it may cause a safety problem.
- (2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
- (3) Operations in a corrosive gas atmosphere or improper environments such as high-temperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
- (4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
- (5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
- (6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
- (7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
- (8) This product does not include a DC-cutting device. Application of a DC voltage between the Balance port and the Unbalance port may cause product deterioration or breakage.
  - \* If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.

### [Remarks]

- \*1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
- \*2: The production process of this product does not use any ozone-depleting chemicals (OZC) regulated by the Montreal Protocol.
- \*3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

| Balun                         |       | Delive    | y Specif  | ication | EHF2BE0920                         |  |  |
|-------------------------------|-------|-----------|-----------|---------|------------------------------------|--|--|
| Enact. Date November 15, 2002 | P.S.M | Approval  | Check     | Plan    | Cautions                           |  |  |
| Enfo. Date November 15, 2002  |       | M. Mizuno | M. Mizuno | H. Ito  | Drawing No.<br>151-EHF-2BE0920 9-5 |  |  |

# [Packaging materials] 1. Materials 1)

- 1) Embossed carrier tape (Refer to the attachment)
  2) Top tape: Anti-static

- 3) Packaging box (Refer to the attachment)4) Packaging tape, carrier-securing adhesive tape

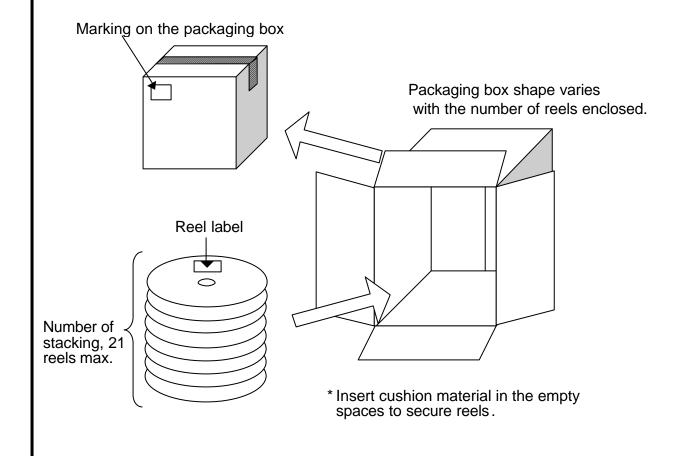
## 2. Specification

| No. | Item                                  | Condition  | Remarks  |
|-----|---------------------------------------|--|--|
| 1   | Reel outer diameter                   | Refer to the attachment.   |  |
| 2   |                                       | Refer to the attachment.   |  |
| 3   |                                       | Refer to the attachment.   |  |
| 4   | Quantity in a reel                    |  |  |
| 5   | Taping direction                      | Tape unreeling direction (with markings facing up)   |  |
| 6   | Top tape<br>attachment<br>position    | Top tape  8.0+/-0.2mm    Top tape  | Tape breaks force.  Min. 10N Top cover tape strength.  Min. 10N Tape peel force.  0.11.0N Tape peel angle.  165180degree Reel weight.  Max 1500g |
| 7   | Label attachment position             | Tape unreeling direction   | Indicated Item Pat No., Lot No. Quantity, Maker Country of Origin  |
| 8   | Tape leader part and tape ending part | Ending part Product-loaded part Embossed carrier Top tape  200~220mm (Product-unloaded part) 100~150mm, 25~38 pieces worth, (Product-unloaded part) 300~ 400mm |  |
| 9   | Missing products                      | No missing products shall be allowed.  |  |
| 10  |                                       | <u> </u>   | 84000 pieces/box(Max)  |
|     |                                       |  |  |

| Balun                         | Delivery Specification |           |           |        |  | EHF2BE0920                         |
|-------------------------------|------------------------|-----------|-----------|--------|--|------------------------------------|
| Enact. Date November 15, 2002 | P.S.M                  | Approval  | Check     | Plan   |  | Packaging specification 1          |
| Enfo. Date November 15, 2002  |                        | M. Mizuno | M. Mizuno | H. Ito |  | Drawing No.<br>151-EHF-2BE0920 9-6 |

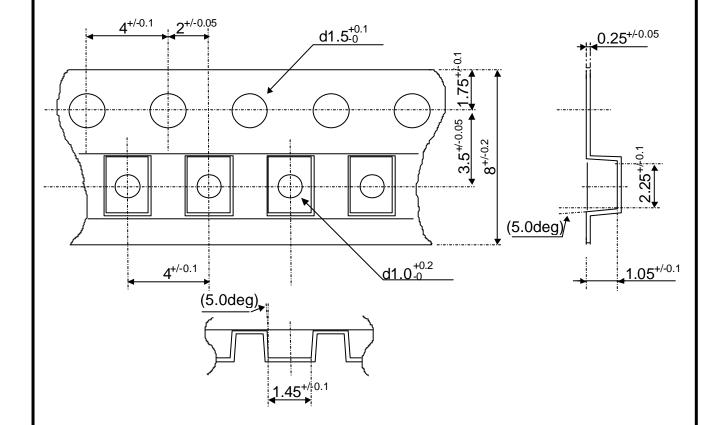
#### 1. Method

- 1) Load products in each cavity of an embossed carrier tape, in the correct orientation, by leaving the product-unloaded part shown in Item No. 8(P9-6) of the packaging specification.
- 2) Heat-seal a top tape in good alignment on the carrier tape.
- 3) After 4000 pieces are loaded and reeled, provide a product-unloaded part at the tape-leader portion. Secure the tip of the carrier tape with a piece of adhesive tape.
- 4) Stack the reels (21 reels max.) and enclose them in a packaging box. Close the flaps with a piece of adhesive tape.
- 5) Provide markings on the packaging box.
  - < Items to be indicated >
    - 1. Part No.
    - 2. Quantity
    - 3. Lot No.
    - 4. Manufacturer name
    - 5. Country of origin



| Balun                         | Delivery Specification |           |           |        | EHF2BE0920                         |  |
|-------------------------------|------------------------|-----------|-----------|--------|------------------------------------|--|
| Enact. Date November 15, 2002 | P.S.M                  | Approval  | Check     | Plan   | Packaging specification 2          |  |
| Enfo. Date November 15, 2002  |                        | M. Mizuno | M. Mizuno | H. Ito | Drawing No.<br>151-EHF-2BE0920 9-7 |  |

## [Embossed tape dimensions] Unit: mm



## <Remarks>

- (1) Unspecified corner radius shall be 0.3mm max.
- (2) Cumulative pitch error of sprocket holes shall be +/-0.2mm for 10 pitches.

| Balun                         | Delivery Specification |           |                    |                | EHF2BE0920                         |
|-------------------------------|------------------------|-----------|--------------------|----------------|------------------------------------|
| Enact. Date November 15, 2002 | P.S.M                  | Approval  | Check<br>M. Mizuno | Plan<br>H. Ito | Packaging specification 3          |
| Enfo. Date November 15, 2002  |                        | M. Mizuno |                    |                | Drawing No.<br>151-EHF-2BE0920 9-8 |

